

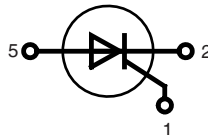
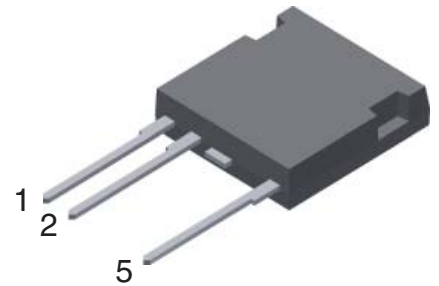
# High Voltage Phase Control Thyristor

in High Voltage  
ISOPLUS i4-PAC™

$$V_{\text{DRM}} = 2200 \text{ V}$$

$$I_{\text{TSM}} = 200 \text{ A}$$

**Part number**  
CNA30E2200PB



## Features / Advantages:

- high voltage thyristor
  - for line frequency
  - chip technology for long term stability
- ISOPLUS i4-PAC™
  - high voltage package
  - isolated back surface
  - enlarged creepage towards heatsink
  - enlarged creepage between high voltage pins
  - application friendly pinout
  - high reliability
  - industry standard outline

## Applications:

- controlled rectifiers
  - power supplies
  - drives
- AC switches
- capacitor discharge control
  - flash tubes
  - X-ray and laser generators

## Package: i4-Pac

- Isolation Voltage: 3000 V~
- Industry convenient outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling

## Disclaimer Notice

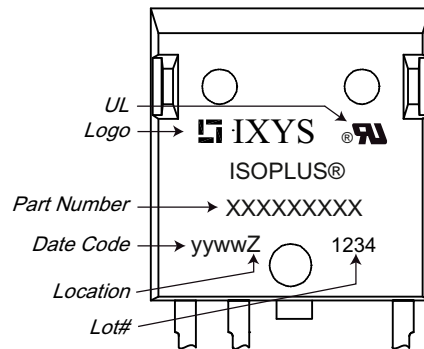
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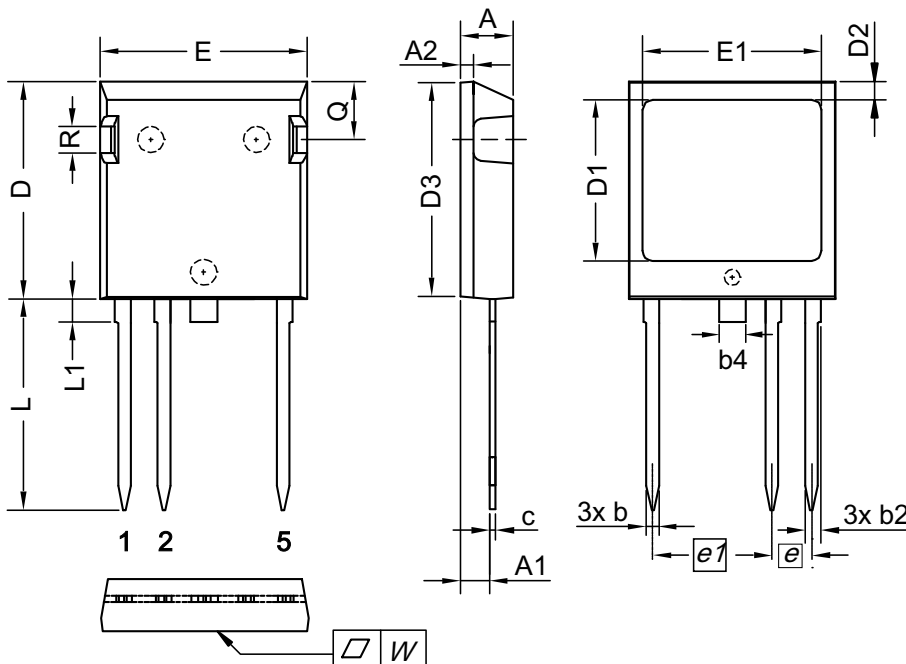
| Thyristor                            |                                                                       |                                                                                                                                                                  |                                                 | Ratings |      |            |          |
|--------------------------------------|-----------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------|---------|------|------------|----------|
| Symbol                               | Definitions                                                           | Conditions                                                                                                                                                       |                                                 | min.    | typ. | max.       | Unit     |
| V <sub>DRM</sub>                     | max. repetitive forward blocking voltage                              |                                                                                                                                                                  |                                                 |         |      | 2200       | V        |
| V <sub>DSM</sub>                     | max. non-repetitive forward blocking voltage                          |                                                                                                                                                                  |                                                 |         |      | 2300       | V        |
| V <sub>RRM</sub> / RSM               | max. repetitive reverse voltage / max. non-repetitive reverse voltage |                                                                                                                                                                  |                                                 |         |      | 1650       | V        |
| I <sub>TSM</sub>                     | max. surge on-state current                                           | sine 180°; t = 10 ms; V <sub>R</sub> = 0 V                                                                                                                       | T <sub>VJ</sub> = 25°C                          |         |      | 200        | A        |
| (di/dt) <sub>cr</sub>                | critical rate of rise of current                                      | f = 50 Hz; t <sub>p</sub> = 200 μs; V <sub>D</sub> = 2000 V<br>di <sub>G</sub> /dt = 0.45 A/μs; I <sub>G</sub> = 0.45 A<br>non repetitive; I <sub>T</sub> = 45 A |                                                 |         |      | 150        | A/μs     |
| (dv/dt) <sub>cr</sub>                | critical rate of rise of voltage                                      | V <sub>D</sub> = 2200 V<br>R <sub>GK</sub> = ∞; method 1 (linear voltage rise)                                                                                   |                                                 |         |      | 5000       | V/μs     |
| V <sub>T</sub>                       | forward voltage                                                       | I <sub>T</sub> = 45 A                                                                                                                                            | T <sub>VJ</sub> = 25°C                          |         |      | 3.0        | V        |
| V <sub>GT</sub><br>I <sub>GT</sub>   | gate trigger voltage<br>gate trigger current                          | V <sub>D</sub> = 6 V                                                                                                                                             | T <sub>VJ</sub> = 25°C                          |         |      | 2.5<br>250 | V<br>mA  |
| V <sub>GD</sub><br>I <sub>GD</sub>   | gate non-trigger voltage<br>gate non-trigger current                  | V <sub>D</sub> = 2/3 V <sub>DRM</sub>                                                                                                                            | T <sub>VJ</sub> = 25°C                          |         |      | 0.2<br>5   | V<br>mA  |
| I <sub>L</sub>                       | latching current                                                      | t <sub>p</sub> = 10 μs; V <sub>D</sub> = 6 V<br>I <sub>G</sub> = 0.45 A; di <sub>G</sub> /dt = 0.45 A/μs                                                         |                                                 |         |      | 700        | mA       |
| I <sub>H</sub>                       | holding current                                                       | V <sub>D</sub> = 6 V; R <sub>GK</sub> = ∞                                                                                                                        | T <sub>VJ</sub> = 0°C<br>T <sub>VJ</sub> = 70°C | 55      |      | 300        | mA<br>mA |
| t <sub>q</sub>                       | turn-off time                                                         | I <sub>T</sub> = 20 A; t <sub>p</sub> = 300 μs; di/dt = -20 A/μs<br>V <sub>R</sub> = 10 V; dv/dt = 20 V/μs<br>V <sub>D</sub> = 800 V                             |                                                 |         | 100  |            | μs       |
| I <sub>RRM</sub><br>I <sub>DRM</sub> | max. repetitive reverse current<br>max. repetitive off-state current  | V <sub>R</sub> = V <sub>RRM</sub> ; V <sub>D</sub> = V <sub>DRM</sub>                                                                                            |                                                 |         |      | 50<br>200  | μA<br>μA |
| I <sub>DSM</sub> / RSM               | max. single pulse reverse current                                     | V <sub>R</sub> = V <sub>RSM</sub> ; V <sub>D</sub> = V <sub>DSM</sub>                                                                                            |                                                 |         |      | 2          | mA       |

| Package I4-Pac                  |                                                              |                                              | Ratings                             |      |      |          |
|---------------------------------|--------------------------------------------------------------|----------------------------------------------|-------------------------------------|------|------|----------|
| Symbol                          | Definitions                                                  | Conditions                                   | min.                                | typ. | max. | Unit     |
| $I_{RMS}$                       | RMS current                                                  | per terminal                                 |                                     |      | 70   | A        |
| $T_{VJ}$                        | virtual junction temperature                                 |                                              | -40                                 |      | 70   | °C       |
| $T_{op}$                        | operation temperature                                        |                                              | -40                                 |      | 70   | °C       |
| $T_{stg}$                       | storage temperature                                          |                                              | -40                                 |      | 70   | °C       |
| <b>Weight</b>                   |                                                              |                                              |                                     | 5.5  |      | g        |
| $F_C$                           | mounting force with clip                                     |                                              | 20                                  |      | 120  | N        |
| $d_{Spp/App}$<br>$d_{Spb/Appb}$ | creepage distance on surface   striking distance through air | terminal to terminal<br>terminal to backside | 7.2<br>5.1                          |      |      | mm<br>mm |
| $V_{ISOL}$                      | isolation voltage                                            | $t = 1$ second<br>$t = 1$ minute             | 3000<br>2500                        |      |      | V<br>V   |
|                                 |                                                              |                                              | 50/60 Hz, RMS, $I_{ISOL} \leq 1$ mA |      |      |          |

## Product Marking



Dimensions in mm (1 mm = 0.0394")



| Dim. | Millimeter |       | Inches    |       |
|------|------------|-------|-----------|-------|
|      | min        | max   | min       | max   |
| A    | 4.83       | 5.21  | 0.190     | 0.205 |
| A1   | 2.59       | 3.00  | 0.102     | 0.118 |
| A2   | 1.17       | 2.16  | 0.046     | 0.085 |
| b    | 1.14       | 1.40  | 0.045     | 0.055 |
| b2   | 1.47       | 1.73  | 0.058     | 0.068 |
| b4   | 2.54       | 2.79  | 0.100     | 0.110 |
| c    | 0.51       | 0.74  | 0.020     | 0.029 |
| D    | 20.80      | 21.34 | 0.819     | 0.840 |
| D1   | 14.99      | 15.75 | 0.590     | 0.620 |
| D2   | 1.65       | 2.03  | 0.065     | 0.080 |
| D3   | 20.30      | 20.70 | 0.799     | 0.815 |
| E    | 19.56      | 20.29 | 0.770     | 0.799 |
| E1   | 16.76      | 17.53 | 0.660     | 0.690 |
| e    | 3.81 BSC   |       | 0.150 BSC |       |
| e1   | 11.43 BSC  |       | 0.450 BSC |       |
| L    | 19.81      | 21.34 | 0.780     | 0.840 |
| L1   | 2.11       | 2.59  | 0.083     | 0.102 |
| Q    | 5.33       | 6.20  | 0.210     | 0.244 |
| R    | 2.54       | 4.57  | 0.100     | 0.180 |
| W    | -          | 0.10  | -         | 0.004 |

Die konvexe Form des Substrates ist typ. < 0.05 mm über der Kunststoffoberfläche der Bauteilunterseite  
 The convex bow of substrate is typ. < 0.05 mm over plastic surface level of device bottom side

IXYS reserves the right to change limits, test conditions and dimensions.

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3 - 3